

Date: 2011/10/25

Specifications for Approval

Customer	: Mc'Tronic	
Model name	: GX1602110129FRN6G01	REV: A
Description	: LCM (X1602110129FRN601-E9	512-B1020A)

LCD Specification: LCD (SE9512 – 70 – 8693 – 111018 – 1)

ISSUE	ENG	QA	APPROVAL
Lily Li	Bose Xie	Wallace	Michael

Customer Approval	Accept Reject Comment:
	Approved by:



REVISION RECORD (MODEL NO.: GX1602110129FRN6G01)

Revision	Revision Date	Page	Contents
А	2011/10/25		Initial Release and Issue Full Specification





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1. FEATURES

The features of LCD are as follows

* Display mode	: FSTN, Positive, Reflective
* Color	: Display dot : Black
	Background: White
* Display Format	: 16 Character X 2 Line
* IC	: SITRONIX ST7038i-0B
* Interface Input Data	: I ² C Interface MPU
* Driving Method	: 1/17 Duty, 1/5 Bias
* Viewing Direction	: 6 O'clock
* Backlight	: N / A

* LCM technological conditions: RoHS

2. MECHANICAL SPECIFICATIONS

ltem	Specification	Unit
Module Size	66.0(W) x 26.7(H) x 2.1MAX(T)	mm
Viewing Area	61.0MIN(W) x 15.7MIN(H)	mm
Effective Display Area	54.7(W) X 10.78(H)	mm
Dot Size	0.566(W) x 0.6175(H)	mm
Dot Pitch	0.596 (W) x 0.6475(H)	mm

3. ELECTRICAL SPECIFICATIONS

3-1. Absolute Maximum Ratings (Vss=0V)

ltem	Symbol	Sta	••••		
nem	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage For Logic	Vdd	-0.3	-	+3.6	V
Supply Voltage For LCD Drive	Vout	-0.3	-	+12.0	V
Input Voltage	Vin	-0.3	-	Vdd+0.5	V
Operating Temp.	Тор	-20	-	+70	°C
Storage Temp.	Tst	-40	-	+80	°C

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3. ELECTRICAL SPECIFICATIONS (Continued)

3-2. Electrical Characteristics (Vss=0V)

ltem		Symbol	Test Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage		Vdd	-	2.1	3.0	3.3	V
LCD Drive Voltage (Recommended Voltage		V _{OP} =V0–Vss	Ta=0~50°C	3.41	3.71	4.01	V
	"H" Level	V _{IH}		0.8Vdd	-	Vdd	V
Input Voltage	"L" Level	V IL	-	-	-	0.2Vdd	V
	"H" Level	V _{OH}	I _{ОН} = -1.5 mA	1.4	-	-	V
Output Voltage	"L" Level	V _{OL}	I _{OL} = 2.0mA	-	-	0.66	V
Current Cons	sumption	I _{DD}	Vop=3.71V Vdd=3.0V	-	-	2.0	mA

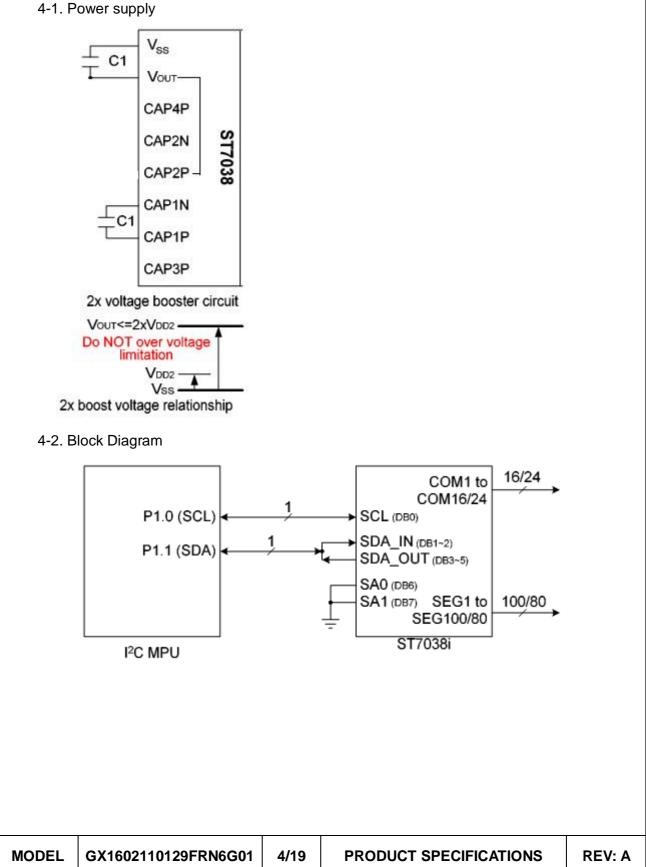
NOTE: 1) Duty Ratio=1/17, Bias Ratio=1/5

2) Measuring in Dots ON-state

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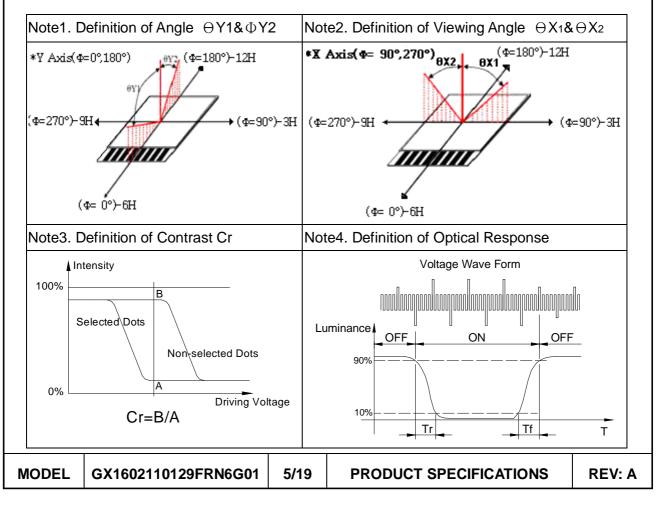
4. POWER SUPPLY AND BLOCK DIAGRAM





5. ELECTRO – OPTICAL CHARACTERISTICS

Ite	m	Symbol	Temp.	Min.	Тур.	Max.	Unit	Conditions	Note
Viewing Angle Cr <u>></u> 2	Φ=0°	θ1			45				
	Φ=180°	θ2	25° ⊂		40		Deg.	-	1.0
	Φ=90°	⊖3	25 ℃		35				1,2
	Φ=270°	θ4			35				
Viewing Direction						60'cloc	k		
Cont Rat		Cr	25 ℃	2.0	11.38	12.13	-	$\Theta = 0^{\circ}$ $\Phi = 0^{\circ}$	3
Respo Time(onse	Tr	25 °C	-	186	300	ma	$\Theta = 0^{\circ}$	4
	rise)	11	0 °C	-	950	1150	ms	$\Phi = 0^{\circ}$	4
Respo	onse	Tf	25 °C	-	258	300	ms	$\Theta = 0^{\circ}$	4
Time	(fall)	11	0 °C	-	950	1150	1115	$\Phi = 0^{\circ}$	4





6. TERMINAL PIN FUNCTION

Pin NO.	Symbol	1/0	Functions
1	CAP1N	Power	For voltage booster circuit (VDD-VSS).
2	CAP1P	Supply	External capacitor about 0.1u ~ 4.7uF.
3	Vout		DC/DC voltage converter. Connect a capacitor between this terminal and VIN when the built-in booster is used.
4	Vdd	Power Supply	2.1V to 3.3V.
5	Vss	Power Supply	0V.
6	SDA	I	Serial data input.
7	SCL	I	Serial clock input.
8	/RST	I	External reset pin. Low active.

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7.INSTRUCTION DESCRIPTION (ST7038-0B)

67-64 63-60	2.00000	0001	0010	caracter 20	0100	0101	2010.000	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000				8	8								3			
0001																
0010					₿		b			Æ						
0011																
0100					D										4	
0101																
0110	*															
0111																
1000				8	Н		h						*			
1001																
1010																2
1011					K					8						*
1100															8	*
1101															8	
1110																
1111																
ODEL		X160	2110 [,]	129FF	RN6G	01	7/19		PRO		SPE	CIEIC				REV:



7.INSTRUCTION DESCRIPTION

				nstr	ucti	on (Cod	e				Exec	Time	
Instruction	AO	RW		DB6 DB7		DB4	DB3	DB2	DB1	DBO	Description	OSC= 260.4K	OSC= 284.1K	OSC= 531.1K
				101		_						Hz	Hz	Hz
Default Instru	ictic	on T	able	(IS	1:0]	: Do	n't	Care	e)			1/2/		
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to clear DDRAM and set AC to "00H".	1.8 ms	1,6 ms	1ms
Return Home	0	0	0	0	0	0	0	0	1	x	Set AC to "00H". It will return cursor to the original position if shifted. The contents in DDRAM are not changed.	93 us	85 us	70 u
Set Entry Mode	0	0	0	0	0	0	0	1	I/D	s	Set cursor move direction and display shift direction. The effects are performed after each data access (write or read).	93 us	85 us	70 u
Display Control	0	0	0	0	0	0	1	D	С	В	D=1: Entire display on; C=1: Cursor on; B=1: Cursor position on.	93 us	85 us	70 u
Function Set	0	0	0	0	1	DL	x	x	IS1	IS0	DL: Interface data is 8/4 bits; IS[1:0]: select instruction table.	93 us	85 us	70 u
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address into AC (address counter).	93 US	85 US	70 u
Read Status	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Before next access, Check BF will know if the internal operation is finished or not. The contents of AC (address counter) can also be read.	0	0	0
Write Data	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM/ICONRAM)	93 us	85 us	70 u
Read Data	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM/ICONRAM)	93 us	85 us	70 u
Instruction ta	ble	0: 15	5[1:0)]=(0),0)	2	i 3	j	(8)			3	20 - 10 	
Cursor or Display Shift	0	0	0	0	0	1	SIC	R/L	x	x	S/C and R/L: Immediately move cursor or shift display by 1.	93 us	85 us	70 ut
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address into AC (address counter)	93 us	85 us	70us



7.INSTRUCTION DESCRIPTION(Continued)

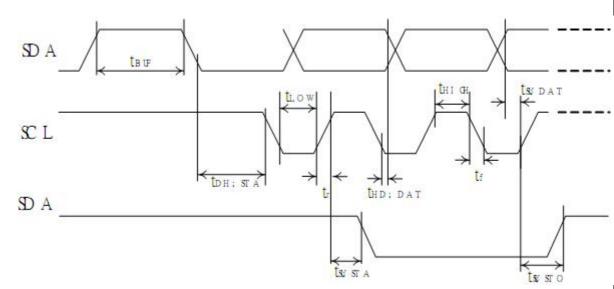
Follower Control	0	0	0	0	0	1	BS2	BS1	OPF2	OPF1	BS2~1: Bias select; OPF2~1: Select built-in voltage follower circuit.	93 us	85 us	70us
Set ICON RAM Address	0	0	0	1	0	0	AC3	AC2	AC1	AC0	Set ICON address into AC (address counter).	93 us	85 us	70 us
V0 Control 1	0	0	0	1	0	1	PD	VC6	VC5	VC4	PD: Power down; VC6~4: Set V0 (High-nibble).	93us	85us	70us
ICON/Power Control	0	0	0	1	1	0	Ion	Bon	Ron	Fon	Ion: ICON display on/off; Bon: Set booster circuit on/off; Ron: Set regulator circuit on/off; Fon: Set follower circuit on/off.	93 us	85 us	70 u
V0 Control 2	0	0	0	1	1	1	VC3	VC2	VC1	VC0	Set V0 (Low-nibble).	93 US	85 us	70 u
Instruction ta	ble	2: 15	5[1:0)]=(1	,0)	-	1		-	-			<u> </u>	-
Set Display Mode	0	0	0	0	0	-	UD	DH	N2	N1	UD: Double Height Position (DHu or DHd); DH: Double Height; N2, N1: Display line number.	93 us	85 us	70 u
Select CGRAM & COM/SEG direction	0	0	0	1	0	0	OPR2	OPR1	SHLS	SHLC	OPR2~1: CGRAM mapping select SHLS: Set SEG scan direction SHLC: Set COM scan direction	93 us	85 us	70 u
Set Frame Rate	0	0	0	1	0	1	0	FR2	R	FRO	FRC2~0: Select Frame Rate	93 US	85 US	70 u

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8. AC Characteristics

I2C Interface



ltem	Signal	1.1	Conditio n	VDD=1.8V Rating		VDD=2.5V Rating		VDD=3.3V Rating		Units
		ol		Min.	Max.	Min.	Max.	Min.	Max.	
SCL clock frequency		f _{SCLK}		DC	400	DC	400	DC	400	KHz
SCL clock low period	SCL	t _{LOW}	1 - [1.3	- 2 -	1.3	-	1.3	12. 2	
SCL clock high period	1	tHIGH	1 1	0.6	22.93	0.6	<u>10</u> 0	0.6	9 <u>083</u> (3)	us
Data set-up time	SI	t _{SU;DAT}		300	-	200	-	100	-	ns
Data hold time	3	t _{HD:DAT}		0	0.9	0	0.9	0	0.9	us
SCL,SDA rise time	SCL,	tr		10-10-	300	3 <u>-1</u> 3	300	31 <u>-</u> 1	300	ns
SCL,SDA fall time	SDA	tr		(<u>—</u>)	300	3 <u>—</u> 2	300	10 2	300	
Capacitive load represent by each bus line	-	C _o		-	400	-	400	-	400	pf
Setup time for a repeated START condition	SI	t _{su;sta}	1 2-3 0	0.7	<u>_</u>	0.6	223	0.6	<u>1</u> 29	us
Start condition hold time	s	t _{HD;STA}		0.6	-	0.6	-	0.6	-	us
Setup time for STOP condition	_	t _{su;sto}	22-32	0.6	-	0.6	-	0.6	-	us
Bus free time between a Stop and START condition	SCL	t _{BUF}	.—	1.3	4	1.3	_	1.3		us

Note: All timing is specified using 20% and 80% of VDD as the reference.

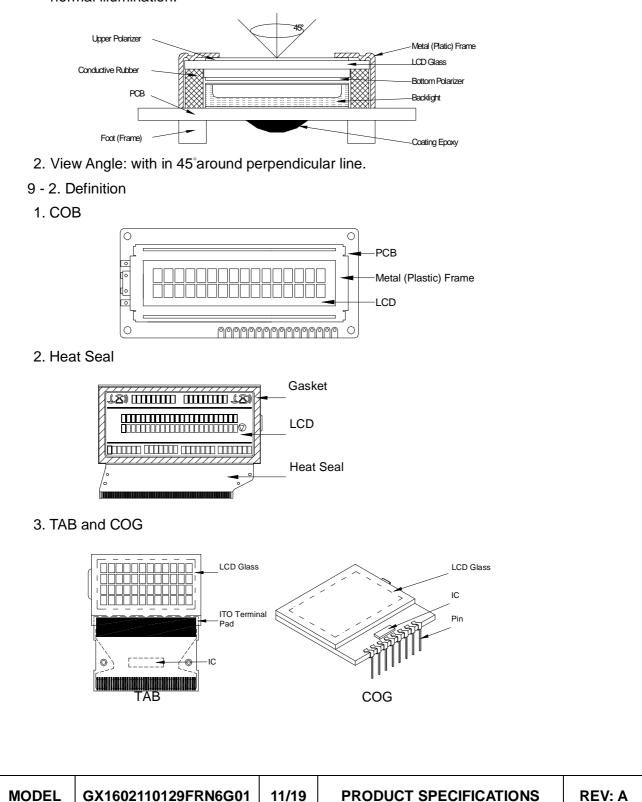
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Display the World

9. QUALITY SPECIFICATIONS

- 9 1. LCM Appearance and Electric inspection Condition
- 1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.





Display the World

9. QUALITY SPECIFICATIONS (Continued)

9-3. Sampling Plan and Acceptance

1.Sampling Plan

MIL - STD - 105E (\parallel) ordinary single inspection is used.

2. Acceptance

Major defect:	AQL = 0.25
Minor defect:	AQL = 0.65

9-4. Criteria

1.COB

Defect	Inspection Item	Inspection Standards						
Major	PCB copper flakes peeling off	Any copper flake in viewing Area should be greater than 1.0mm ²	Reject					
Major	Height of coating epoxy	Exceed the dimension of drawing	Reject					
Major	Void or hole of coating epoxy	Expose bonding wire or IC	Reject					
Major	PCB cutting defect	Exceed the dimension of drawing	Reject					

2.SMT

Defect	Inspection Item	Inspection Standa	ırds
Minor	Component marking not readable		Reject
Minor	Component height	Exceed the dimension Of drawing	Reject
Major	Component solder defect (missing , extra, wrong component or wrong orientation		Reject
Minor	Component position shift component soldering pad X D Z Z Y	X < 3/4Z Y > 1/3D	Reject Reject
Minor	Component tilt component p soldering pad	Y > 1/3D	Reject
Minor	Insufficient solder component PAD PCB	<i>θ</i> ≤ 20°	Reject
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9. QUALITY SECIFICATIONS (Continued)

9-4. Criteria (Continued)

3. Metal (Plastic) Frame

Defect	Inspection Item	l II	nspection Standa	rds
Major	Crack / breakage	Any	Reject	
		W	L	Acceptable of Scratch
		w<0.1mm	Any	Ignore
		0.1 <u><</u> w<0.2mm	L <u><</u> 5.0mm	2
Minor	Frame Scratch	0.2 <u><</u> w<0.3mm	L <u><</u> 3.0mm	1
		w <u>></u> 0.3mm	Any	0
			reater than 5mm. ch on the back side ignored .	
				Acceptable of Dents / Pricks
		Φ <u><</u>	1.0mm	2
	Frame Dent, Prick	1.0<	⊃ <u><</u> 1.5mm	1
Minor	$\Phi = \frac{L + W}{2}$	1.5r	0	
	2	/ pricks with dis	criteria applicable tance greater than prick on the back s ignored	5mm
Minor	Frame Deformation	Excee	d the dimension of	drawing
Minor	Metal Frame Oxidation		Any rust	

4. Flexible Film Connector (FFC)

Defect	Inspection Item	Inspection Standards	
Minor	Tilted soldering	Within the angle +5°	Acceptable
Minor	Uneven solder joint /bump		Reject
Minor	Hole $\Phi = \frac{L + W}{W}$	Expose the conductive line	Reject
	ψ_{-}	Φ > 1.0mm	Reject
Minor	Position shift $Y \xrightarrow{-\frac{1}{2}} Z_{\underline{\leftarrow}} \xrightarrow{-\frac{1}{2}} D$	Y > 1/3D	Reject
		X > 1/2Z	Reject

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Display the World

9. QUALITY SPECIFICATIONS (Continued)

9-4. Criteria (Continued)

5. Screw

Defect	Inspection Item	Inspection Standards		
Major	Screw missing/loosen		Reject	
Minor	Screw oxidation	Any rust	Reject	
Minor	Screw deformation	Difficult to accept screw driver	Reject	

6. Heatseal 🚿 TCP 🚿 FPC

Defect	Inspection Item	Inspection Standards	
Major	Scratch expose conductive layer		Reject
Minor	HS Hole $\Phi = \frac{L + W}{2}$	Φ > 0.5mm	Reject
Major	Adhesion strength	Less than the specification	Reject
Minor	Position shift $y \xrightarrow{-\psi} - y \xrightarrow{-\psi} - y$	Y > 1/3D	Reject
		X > 1/2Z	Reject
Major	Conductive line break		Reject

7. LED Backing Protective Film and Others

Defect	Inspection Item	Inspection Standards				
		Acceptable number of units				
		⊕ <u><</u> 0.10mm	Ignore			
		0.10<⊕ <u><</u> 0.15mm	2			
Minor	LED dirty, prick	0.15<⊕ <u><</u> 0.2mm	1			
		Φ >0.2mm	0			
		The distance between any two spots should be ≥ 4 Any spot/dot/void outside of viewing area is accept				
Minor	Protective film tilt	Not fully cover LCD				
Major	COG coating	Not fully cover ITO circuit				

8. Electric Inspection

Defect	Inspection Item	Inspection Standards	
Major	Short		Reject
Major	Open		Reject

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9. QUALITY SPECIFICATIONS (Continued)

9-4. Criteria (Continued)

9. Inspection Specification of LCD

	insp	ect Item			In	spectior	า 5	Standard	S	
		* Glass Scratch	W	/		<u><</u> 0.03	0.	03 <w<u><0.0</w<u>	5 V	V>0.05
		 * Polarizer Scratt 	tch L			L<5		L<3		Any
Minor	Linear Defect	 Fiber and Line 	AL.			1		1		Reject
		material	Not		is the la	anath and	N is th	ne width of		-
		* Foreign materi			⊕ <u><</u> 0.1	-		0.15<⊕ <u><</u> 0		Φ >0.2
		between glass ar			3EA /	_	0.10		.2	
	Black Spot and	polarizer or glass			100mm	2 2		1		0
Minor	Polarizer Pricked	and glass * Polarizer hole protuberance by external force		I A I	Φ is the	average d		er of the de fects > 10n		
		 Unobvious 	Φ	•	Φ	<u><</u> 0.3	0.3	<Φ <u><</u> 0.5	0.	5< Φ
	White Spot	transparant foreig material between	NC		3EA /	100mm ²		1		0
Minor	and Bubble in polarizer	glass and glass or glass and polariz * Air protuberan between polarize and glass	er ce _{Note}	0		-		er of the de fects > 10n		
			Φ)	⊕ <u><</u> 0.10	0.10 <⊕	<u><</u> 0.20	0.20<Φ <u>-</u>	<u><</u> 0.25	⊕>0.25
			ACC NC	C.).	3EA / 100mm ²	2 2		1		0
Minor	Segment	T WI -		Ì	W is mor	e than 1/2	segm	ent width		Reject
	Defect		7 Not		Φ= <u>L</u> .	2				
			/	[Distance	between t	wo dei	fect is 10m	m	
			Φ		⊕ <u><</u> 0.10	0.10 <Φ	<u><</u> 0.20	0.20<⊕ <u>∢</u>	<u><</u> 0.25	Φ>0.25
Minor	Protuberant Segment		W		Glue	W <u><</u> 1/2 W <u><</u> 0		W <u><</u> 1/2 W <u><</u> 0		Ignore
		Φ = (L + W) / 2	ACC NC		3EA / 100mm ²	2 2		1		0
		$\wedge \wedge \wedge$	1. S	Segr	nent					
				В	E	8 <u><</u> 0.4mm	0.4<	B <u><</u> 1.0mm	B>1	1.0mm
	Assembly			B-A	4 E	8-A<1/2B	B·	A<0.2	B-A	<0.25
Minor	Mis-alignment		J	ludg	ge A	cceptable	Acc	ceptable	Acc	eptable
			2. D	ot N	Matrix					
					rmation>					Reject
Minor	Stain on LCD Panel Surface		or a	a si	imilar oi		vise, j	ed lightly w udged aco /hite Spot"		
		Ι	<u> </u>						I	



10. RELIABILITY

NO.	ltem	Condition	Criterion
1	High Temperature Operating	70℃, 96Hrs	
2	Low Temperature Operating	-20℃, 96Hrs	
3	High Humidity	50℃, 90%RH, 96Hrs	
4	High Temperature Storage	80℃, 96Hrs	No defect in cosmetic
5	Low Temperature Storage	-40℃, 96Hrs	and operational function allowable.
		Random wave	Total current Consumption should
6	Vibration	10 ~ 100Hz	be below double of initial value.
U	Violation	Acceleration: 2G	
		60 Minute	
		-10°C to 25°C to 60°C	
7	Thermal Shock	(60Min) (15Min) (60Min)	
		10Cycles	
		Contract Discharge Voltage: +1 ~ 5kV and –1 ~ –5kV	There will be discharged ten times
8	ESD Testing		at every discharging voltage cycle. The
		Air Discharge Voltage: +1 ~ 8kV and –1 ~ -8kV	voltage gap is 1kV.

Note: 1) Above conditions are suitable for GOLDENTEK standard products.

2) For restrict products, the test conditions listed as above must be revised.

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11. HANDLING PRECAUTIONS

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifloroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Ketone
- Aromatics
- (3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.

- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.
- (5) Caution for operation
 - It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.

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11. HANDLING PRECAUTIONS (Continued)

- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them.

However those phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the relative condition of 40°C, 80%RH or less is required.

(6) Storage

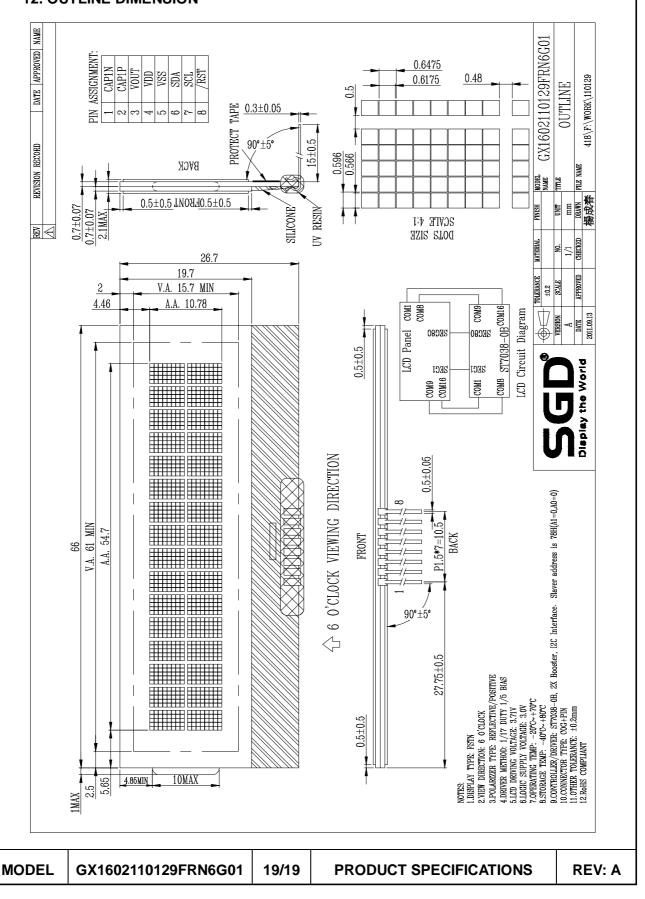
In the case of storing for a long period of time (for instance ,for years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)
- (7) Safety
 - It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol.
 - Which should be burned up later.
 - When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

MODEL	GX1602110129FRN6G01	18/19	PRODUCT SPECIFICATIONS	REV: A



12. OUTLINE DIMENSION





SAMPLE OUTGOING INSPECTION REPORT (LCM)

Data: 2011/10/25

NO.: QAB10018

Customer			Product NO. Dr		Drivin	riving Voltage		Testing Condition		Quantity				
Mectronic		GX	GX1602110129FRN6G01		V _{OP}	V _{OP} =3.71V		25 ℃		25Pcs				
Inspection Result														
Items Specification														
Display Mode W / B Mode B / W Mode Yellow Mode Blue Mode Gray M									Gray Mode					
Polarizer Type		Reflective						⊖ Transflective				○ Transmissive		
Viewing direction		○ 3 O'clock				6 O'o	6 O'clock O S			9 O'clock 🛛 12 O'clock				
Electrical / Appearance														
ltem		Inspection Method					Specification			Inspection Result				
Appearance		Spot Gauge Caliper			Fir	Final Inspection Criteria			• 0	К	⊖ NG			
Electrical		LCM Tester				P	Product Specification			• 0	К	⊖ NG		
Pattern		LCM Tester					Drawing			• 0	К	⊖ NG		
Dimension / Supply Current														
ltem	Spec.(m	m)	NO.1	NO.2	NO.3	NO.4	NO.5	Re	sult		Fig.			
L1	66.0 <u>+</u> 0.	2	65.95	65.91	66.03	65.96	65.91	• ок	0 N	G				
L2 15.0 <u>+</u> 0.5 W1 26.7 <u>+</u> 0.2		5	14.98	14.81	15.12	14.96	14.96	• ок	0 N	G				
		2	26.53	26.59	26.67	26.66	26.62	• ок	0 N	G				
W2	19.7 <u>+</u> 2.	0	19.63	19.70	19.70	19.65	19.69	• ок	0 N	G				
т	2.1 Ma	x	2.03	2.03	2.02	2.03	2.05	• ок	0 N	G				
Designed		Joan Check			ked	1	/	Ap	proved	v	Vallace			

Doc. NO.: F10018A .